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N-Channel Enhancement Mode Field Effect Transistor NDT3055

General Description

These N–Channel enhancement mode power field effect transistors are produced using **onsemi**'s proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on–state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as DC motor control and DC/DC conversion where fast switching, low in–line power loss, and resistance to transients are needed.

Features

- 4 A, 60 V
 - $R_{DS(ON)} = 0.100 \Omega @ V_{GS} = 10 V$
- High Density Cell Design for Extremely Low RDS(ON)
- High Power and Current Handling Capability in a Widely Used Surface Mount Package
- This is a Pb–Free Device

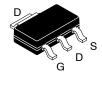
Symbol	Parameter	Value	Unit
V _{DSS}	Drain-Source Voltage	60	V
V _{GSS}	Gate-Source Voltage	±20	V
Ι _D	Drain Current		А
	– Continuous (Note 1a)	4	
	– Pulsed	25	
PD	Maximum Power Dissipation		W
	(Note 1a)	3	
	(Note 1b)	1.3	
	(Note 1c)	1.1	
T _J , T _{STG}	Operating and Storage Temperature Range	–65 to 150	°C

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

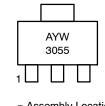
THERMAL CHARACTERISTICS (T_A = 25°C, unless otherwise noted)

Symbol	Parameter	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	42	°C/W
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case (Note 1)	12	°C/W



SOT-223 CASE 318H-01

MARKING DIAGRAM



= Assembly Location

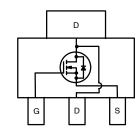
Y = Year

A

W = Work Week 3055 = Specific Device Code

(Note: Microdot may be in either location)

PINOUT DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping [†]
NDT3055	SOT-223 (Pb-Free)	4000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

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ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
OFF CHARA	CTERISTICS					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \ \mu\text{A}$	60	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_{I}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C	-	63	-	mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	10	μA
		V_{DS} = 48 V, V_{GS} = 0 V, T_{J} = 125°C	-	-	100	
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	-100	nA
ON CHARAC	CTERISTICS (Note 2)	·	•		•	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2	3	4	V
		$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$, $T_J = 125^{\circ}C$	1.5	2.4	3	
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 4 A	-	0.084	0.1	Ω
		V_{GS} = 10 V, I_{D} = 4 A, T_{J} = 125°C	-	0.14	0.18	1
I _{D(ON)}	On-State Drain Current	V _{GS} = 10 V, V _{DS} = 10 V	15	-	-	А
9 _{FS}	Forward Transconductance	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 4 \text{ A}$	-	6	-	S
YNAMIC C	HARACTERISTICS					
C _{iss}	Input Capacitance	V_{DS} = 30 V, V_{GS} = 0 V, f = 1.0 MHz	-	250	-	pF
C _{oss}	Output Capacitance		-	100	-	pF
C _{rss}	Reverse Transfer Capacitance		-	30	-	pF
WITCHING	CHARACTERISTICS (Note 2)					
t _{d(on)}	Turn – On Delay Time	V_{DD} = 25 V, I _D = 1.2 A, V_{GS} = 10 V, R _{GEN} = 50 Ω	-	10	25	ns
t _r	Turn – On Rise Time		-	18	50	ns
t _{d(off)}	Turn – Off Delay Time		-	37	65	ns
t _f	Turn – Off Fall Time		-	30	60	ns
Qg	Total Gate Charge	V_{DS} = 40 V, I_{D} = 4 A, V_{GS} = 10 V	-	9	15	nC
	Gate-Source Charge		-	2.3	-	nC
Q _{gs}	date edulee enarge					

I _S	Maximum Continuous Drain-Source Diode Forward Current		-	-	2.5	А	
V_{SD}	Drain-Source Diode Forward Voltage	V_{GS} = 0 V, I_S = 2.5 A (Note 2)	-	0.85	1.2	V	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

 R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design. Typical R_{0JA} using the board layouts shown below on FR-4 PCB in a still air environment:



a. 42°C/W when mounted on a 1 in² pad of 2 oz copper.



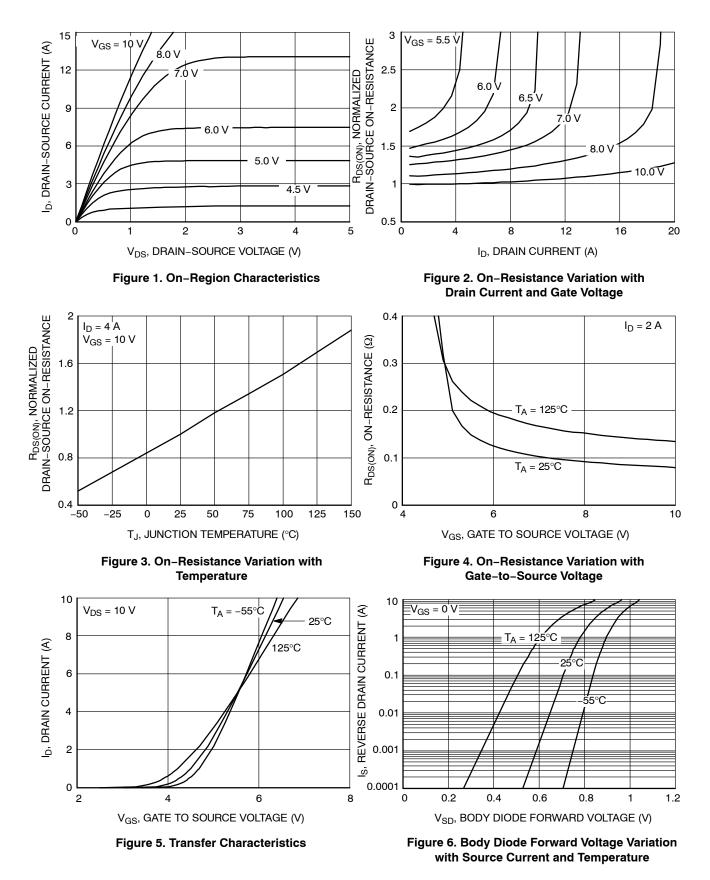
b. 95°C/W when	\perp	c. 110°C/W when
mounted on a 0.066 in ²	φφφ	mounted on a 0.00123
pad of 2 oz copper.		in ² pad of 2 oz Cu

ψ

2. Pulse Test: Pulse Width \leq 300 $\mu s,$ Duty Cycle \leq 2.0%.

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TYPICAL ELECTRICAL CHARACTERISTICS



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TYPICAL ELECTRICAL CHARACTERISTICS (continued)

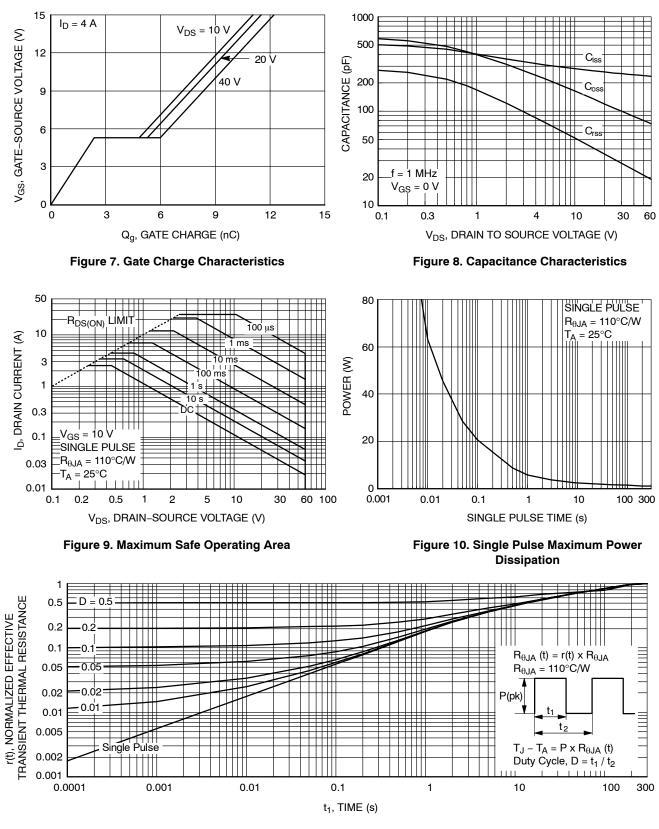
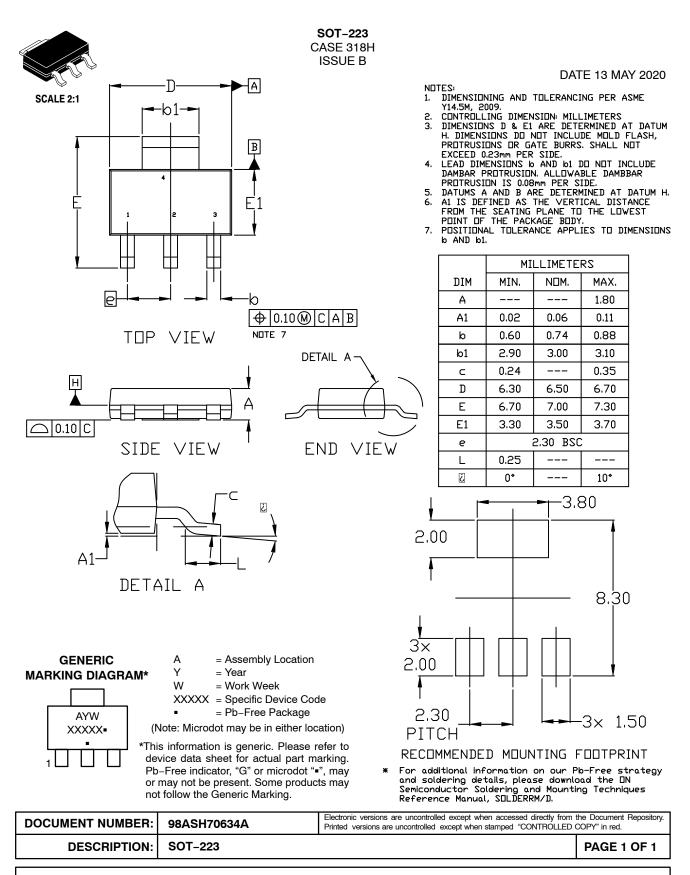


Figure 11. Transient Thermal Response Curve

Thermal characterization performed using the conditions described in Note 1c. Transient thermal response will change depending on the circuit board design.

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